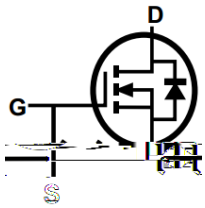
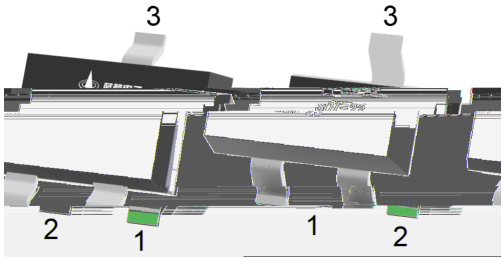
Ω

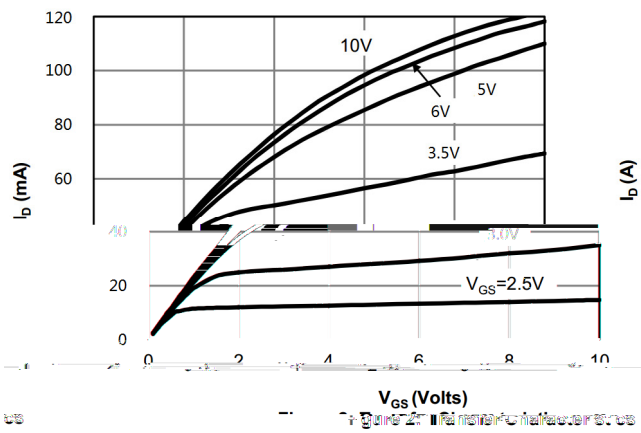
Ω

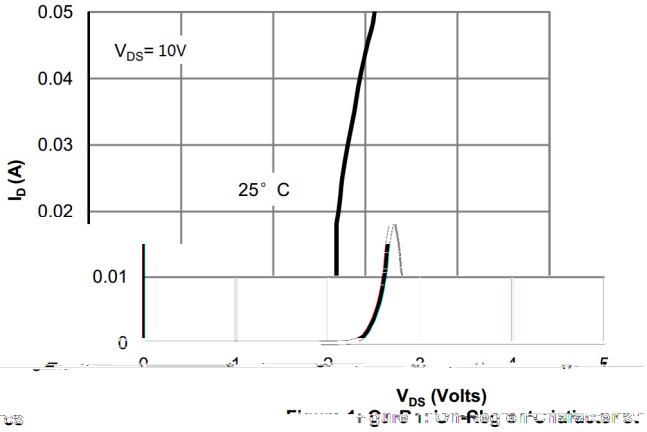




	θ		

		μ				
		μ				
		μ				
						Ω
						Ω
						μ
						μ





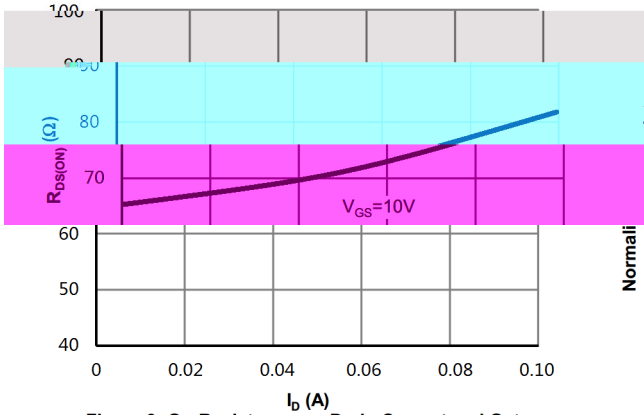


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

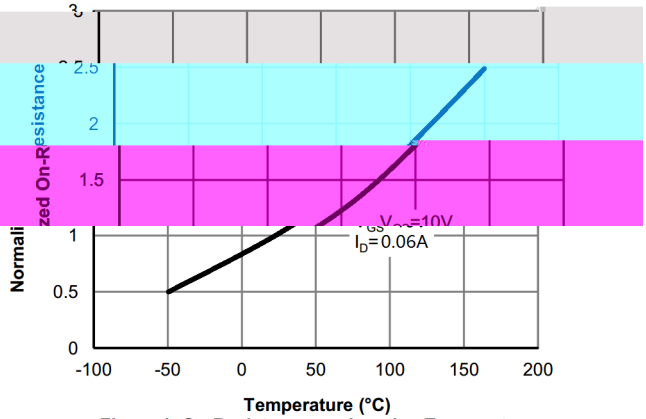
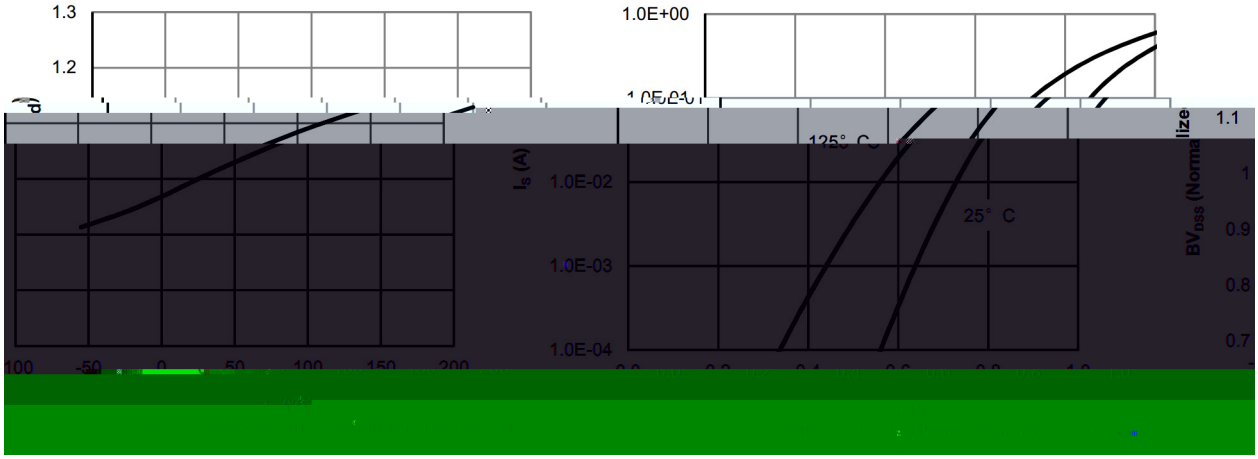


Figure 4: On-Resistance vs. Junction Temperature



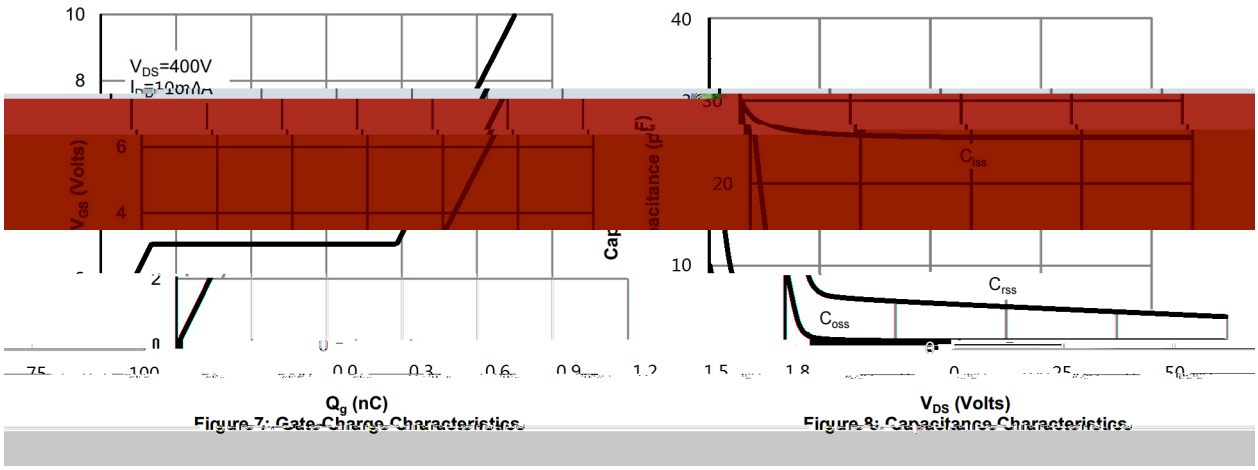


Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

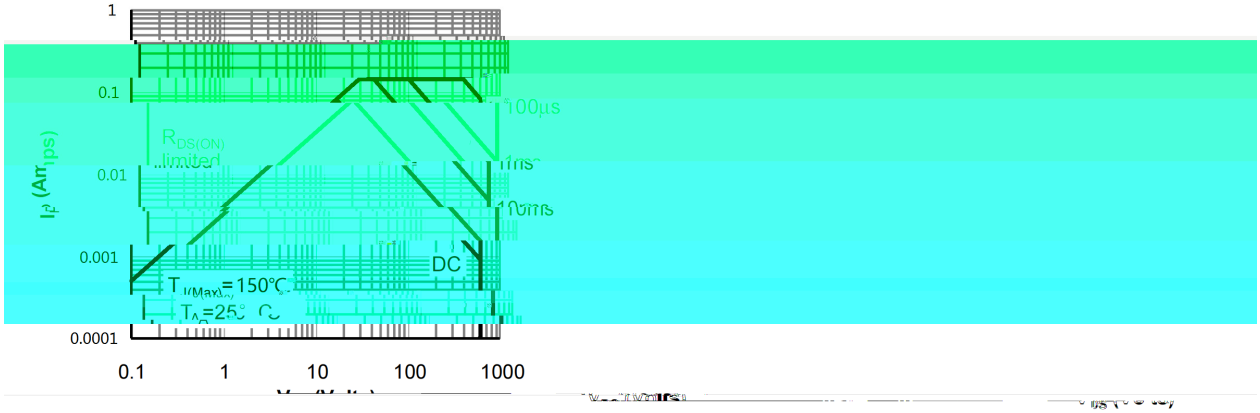


Figure 9: Maximum Forward Biased Safe Operating Area

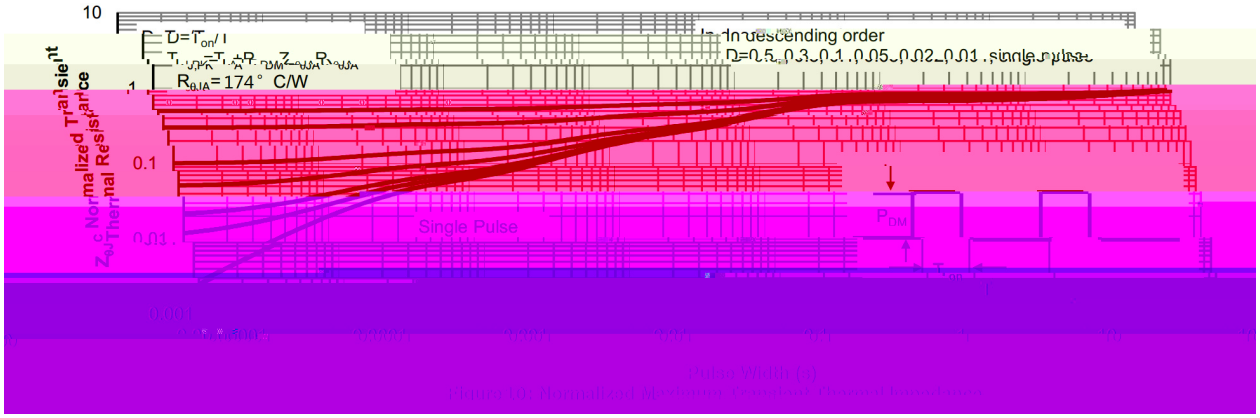
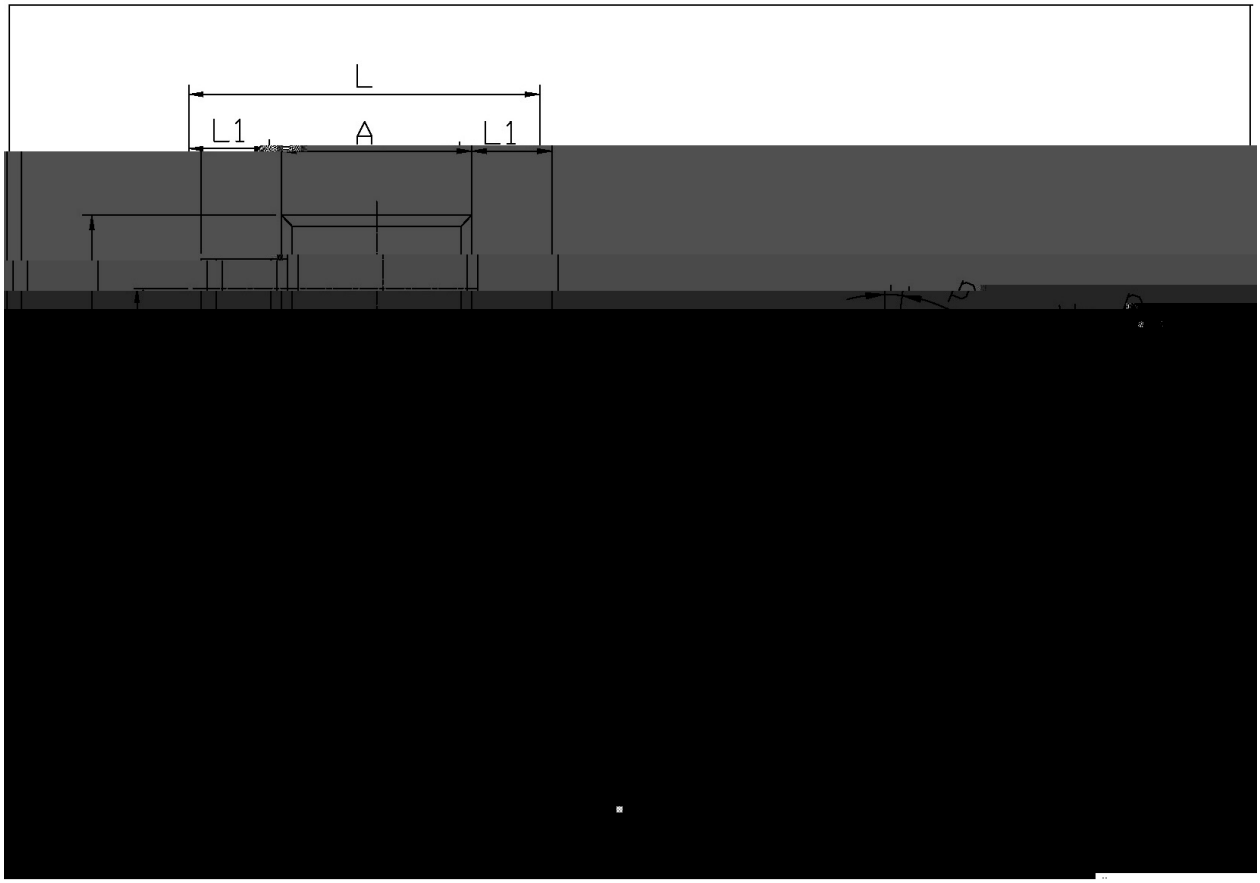
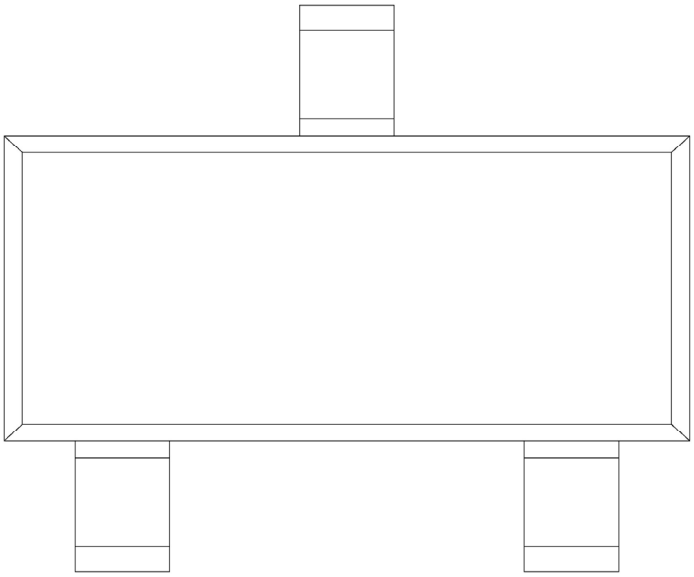


Figure 10: Normalized Maximum Transient Thermal Impedance

SOT-23

单位：mm





Temperature Profile for IR Reflow Soldering(Pb-Free)

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box	-